LM119,LM219,LM319

LM119/LM219/LM319 High Speed Dual Comparator



Literature Number: SNOSBJ2A

LM119/LM219/LM319 High Speed Dual Comparator

General Description

The LM119 series are precision high speed dual comparators fabricated on a single monolithic chip. They are designed to operate over a wide range of supply voltages down to a single 5V logic supply and ground. Further, they have higher gain and lower input currents than devices like the LM710. The uncommitted collector of the output stage makes the LM119 compatible with RTL, DTL and TTL as well as capable of driving lamps and relays at currents up to 25 mA.

The LM319A offers improved precision over the standard LM319, with tighter tolerances on offset voltage, offset current, and voltage gain.

Although designed primarily for applications requiring operation from digital logic supplies, the LM119 series are fully specified for power supplies up to ±15V. It features faster response than the LM111 at the expense of higher power dis-

sipation. However, the high speed, wide operating voltage range and low package count make the LM119 much more versatile than older devices like the LM711.

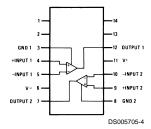
The LM119 is specified from -55° C to $+125^{\circ}$ C, the LM219 is specified from -25° C to $+85^{\circ}$ C, and the LM319A and LM319 are specified from 0° C to $+70^{\circ}$ C.

Features

- Two independent comparators
- Operates from a single 5V supply
- Typically 80 ns response time at ±15V
- Minimum fan-out of 2 each side
- Maximum input current of 1 µA over temperature
- Inputs and outputs can be isolated from system ground
- High common mode slew rate

Connection Diagram

Dual-In-Line Package

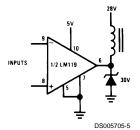


Top View
Order Number LM119J, LM119J/883 (Note 1),
LM219J, LM319J, LM319AM,
LM319M, LM319AN or LM319N
See NS Package Number J14A, M14A or N14A

Note 1: Also available per SMD# 8601401 or JM38510/10306

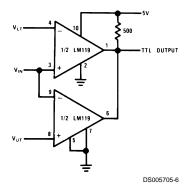
Typical Applications (Note 2)

Relay Driver



Note 2: Pin numbers are for metal can package.

Window Detector



 V_{OUT} = 5V for $V_{LT} \le V_{IN} \le V_{UT}$ V_{OUT} = 0 for $V_{IN} \le V_{LT}$ or $V_{IN} \ge V_{UT}$

Absolute Maximum Ratings (Note 9)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Total Supply Voltage	36V
Output to Negative Supply Voltage	36V
Ground to Negative Supply Voltage	25V
Ground to Positive Supply Voltage	18V
Differential Input Voltage	±5V
Input Voltage (Note 3)	±15V
ESD rating (1.5 $k\Omega$ in series with	
100 pF)	800V
Power Dissipation (Note 4)	500 mW
Output Short Circuit Duration	10 sec

Lead Temperature
(Soldering, 10 sec.)

Soldering Information
Dual-In-Line Package
Soldering (10 seconds)

Small Outline Package
Vapor Phase (60 seconds)

Infrared (15 seconds)

260°C

260°C

215°C

220°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

Operating Temperature Range

Electrical Characteristics (Note 5)

Storage Temperature Range

Parameter	Conditions		Units		
		Min	Тур	Max	
Input Offset Voltage (Note 6)	$T_A = 25^{\circ}C, R_S \le 5k$		0.7	4.0	mV
Input Offset Current (Note 6)	$T_A = 25^{\circ}C$		30	75	nA
Input Bias Current	$T_A = 25^{\circ}C$		150	500	nA
Voltage Gain	T _A = 25°C (Note 8)	10	40		V/mV
Response Time (Note 7)	$T_A = 25^{\circ}C, V_S = \pm 15V$		80		ns
Saturation Voltage	$V_{IN} \le -5 \text{ mV}, I_{OUT} = 25 \text{ mA}$				
	$T_A = 25^{\circ}C$		0.75	1.5	V
Output Leakage Current	$V_{IN} \ge 5 \text{ mV}, V_{OUT} = 35 \text{V}$				
	$T_A = 25^{\circ}C$		0.2	2	μA
Input Offset Voltage (Note 6)	$R_S \le 5k$			7	mV
Input Offset Current (Note 6)				100	nA
Input Bias Current				1000	nA
Input Voltage Range	V _S = ±15V	-12	±13	+12	V
	$V^{+} = 5V, V^{-} = 0$	1		3	V
Saturation Voltage	$V^{+} \ge 4.5V, V^{-} = 0$				
	$V_{IN} \le -6 \text{ mV}, I_{SINK} \le 3.2 \text{ mA}$				
	T _A ≥ 0°C		0.23	0.4	V
	T _A ≤ 0°C			0.6	V
Output Leakage Current	$V_{IN} \ge 5 \text{ mV}, V_{OUT} = 35V,$		1	10	μA
	$V^- = V_{GND} = 0V$				
Differential Input Voltage				±5	V
Positive Supply Current	$T_A = 25^{\circ}C, V^+ = 5V, V^- = 0$		4.3		mA
Positive Supply Current	$T_A = 25^{\circ}C, V_S = \pm 15V$		8	11.5	mA
Negative Supply Current	$T_A = 25^{\circ}C, V_S = \pm 15V$		3	4.5	mA

-65°C to 150°C

Note 4: The maximum junction temperature of the LM119 is 150°C, while that of the LM219 is 110°C. For operating at elevated temperatures, devices in the H10 package must be derated based on a thermal resistance of 160°C/W, junction to ambient, or 19°C/W, junction to case. The thermal resistance of the J14 and N14 packages is 100°C/W, junction to ambient.

Note 5: These specifications apply for $V_S = \pm 15V$, and the Ground pin at ground, and $-55^{\circ}C \le T_A \le +125^{\circ}C$, unless otherwise stated. With the LM219, however, all temperature specifications are limited to $-25^{\circ}C \le T_A \le +85^{\circ}C$. The offset voltage, offset current and bias current specifications apply for any supply voltage from a single 5V supply up to $\pm 15V$ supplies. Do not operate the device with more than 16V from ground to V_S .

Note 6: The offset voltages and offset currents given are the maximum values required to drive the output within a volt of either supply with a 1 mA load. Thus, these parameters define an error band and take into account the worst case effects of voltage gain and input impedance.

Note 7: The response time specified (see definitions) is for a 100 mV input step with 5 mV overdrive.

Note 8: Output is pulled up to 15V through a 1.4 $k\Omega$ resistor.

Note 9: Refer to RETS119X for LM119H/883 and LM119J/883 specifications.

Note 3: For supply voltages less than ±15V the absolute maximum input voltage is equal to the supply voltage.

220°C

Absolute Maximum Ratings LM319A/319 (Note 9)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Total Supply Voltage	36V
Output to Negative Supply Voltage	36V
Ground to Negative Supply Voltage	25V
Ground to Positive Supply Voltage	18V
Differential Input Voltage	±5V
Input Voltage (Note 10)	±15V
Power Dissipation (Note 11)	500 mW
Output Short Circuit Duration	10 sec
ESD rating (1.5 kO in series with	

ESD rating (1.5 k Ω in series with 100 pF) 800V

Storage Temperature Range	-65°C to 150°C
Lead Temperature (Soldering, 10 sec.)	260°C
Soldering Information	
Dual-In-Line Package	
Soldering (10 sec.)	260°C
Small Outline Package	
Vapor Phase (60 sec.)	215°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

Operating Temperature Range

Infrared (15 sec.)

LM319A, LM319 0°C to 70°C

Electrical Characteristics (Note 12)

Parameter	Conditions	LM319A			LM319			Units
		Min	Тур	Max	Min	Тур	Max	
Input Offset Voltage (Note 13)	$T_A = 25^{\circ}C, R_S \le 5k$		0.5	1.0		2.0	8.0	mV
Input Offset Current (Note 13)	$T_A = 25^{\circ}C$		20	40		80	200	nA
Input Bias Current	$T_A = 25^{\circ}C$		150	500		250	1000	nA
Voltage Gain	T _A = 25°C (Note 15)	20	40		8	40		V/mV
Response Time (Note 14)	$T_A = 25^{\circ}C, V_S = \pm 15V$		80			80		ns
Saturation Voltage	$V_{IN} \le -10 \text{ mV}, I_{OUT} = 25 \text{ mA}$							
	$T_A = 25^{\circ}C$		0.75	1.5		0.75	1.5	V
Output Leakage Current	$V_{IN} \ge 10 \text{ mV}, V_{OUT} = 35V,$							
	$V^{-} = {}^{\vee}GND = 0V, T_A = 25{}^{\circ}C$		0.2	10		0.2	10	μΑ
Input Offset Voltage (Note 13)	R _S ≤ 5k			10			10	mV
Input Offset Current (Note 13)				300			300	nA
Input Bias Current				1000			1200	nA
Input Voltage Range	V _S = ±15V		±13			±13		V
	$V^{+} = 5V, V^{-} = 0$	1		3	1		3	V
Saturation Voltage	$V^{+} \ge 4.5V, V^{-} = 0$		0.3	0.4		0.3	0.4	V
	$V_{IN} \le -10 \text{ mV}, I_{SINK} \le 3.2 \text{ mA}$							
Differential Input Voltage				±5			±5	V
Positive Supply Current	$T_A = 25^{\circ}C, V^+ = 5V, V^- = 0$		4.3			4.3		mA
Positive Supply Current	$T_A = 25^{\circ}C, V_S = \pm 15V$		8	12.5		8	12.5	mA
Negative Supply Current	$T_A = 25^{\circ}C, V_S = \pm 15V$		3	5		3	5	mA

 $\textbf{Note 10:} \ \ \text{For supply voltages less than ± 15 the absolute maximum input voltage is equal to the supply voltage.}$

Note 11: The maximum junction temperature of the LM319A and LM319 is 85°C. For operating at elevated temperatures, devices in the H10 package must be derated based on a thermal resistance of 160°C/W, junction to ambient, or 19°C/W, junction to case. The thermal resistance of the N14 and J14 package is 100°C/W, junction to ambient. The thermal resistance of the M14 package is 115°C/W, junction to ambient.

Note 12: These specifications apply for $V_S = \pm 15V$, and $0^{\circ}C \le T_A \le 70^{\circ}C$, unless otherwise stated. The offset voltage, offset current and bias current specifications apply for any supply voltage from a single 5V supply up to $\pm 15V$ supplies. Do not operate the device with more than 16V from ground to V_S .

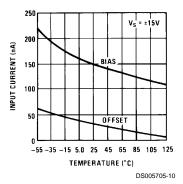
Note 13: The offset voltages and offset currents given are the maximum values required to drive the output within a volt of either supply with a 1 mA load. Thus, these parameters define an error band and take into account the worst case effects of voltage gain and input impedance.

Note 14: The response time specified is for a 100 mV input step with 5 mV overdrive.

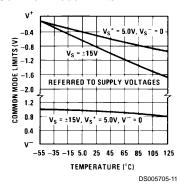
Note 15: Output is pulled up to 15V through a 1.4 $k\Omega$ resistor.

Typical Performance Characteristics LM119A/LM119/LM219

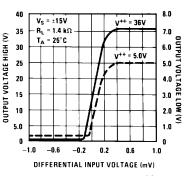
Input Currents



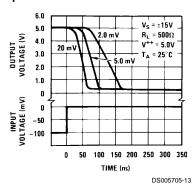
Common Mode Limits



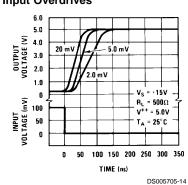
Transfer Function



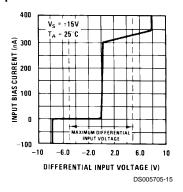
Response Time for Various Input Overdrives



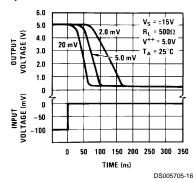
Response Time for Various Input Overdrives



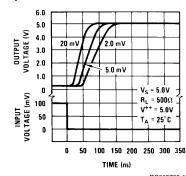
Input Characteristics



Response Time for Various Input Overdrives

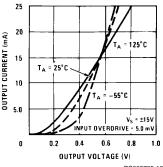


Response Time for Various Input Overdrives



DS005705-17

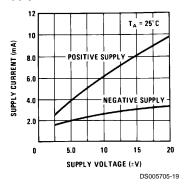
Output Saturation Voltage



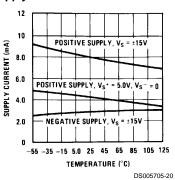
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Typical Performance Characteristics LM119A/LM119/LM219 (Continued)

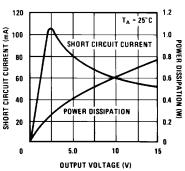
Supply Current



Supply Current



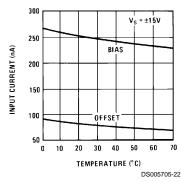
Output Limiting Characteristics



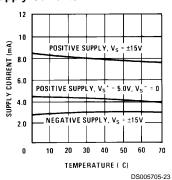
DS005705-21

Typical Performance Characteristics LM319A, LM319

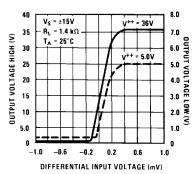
Input Currents



Supply Currents

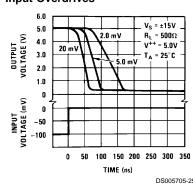


Transfer Function

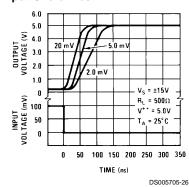


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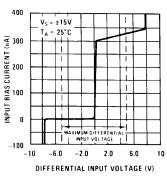
Response Time for Various Input Overdrives



Response Time for Various Input Overdrives



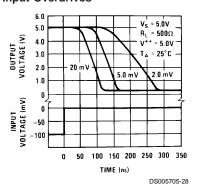
Input Characteristics



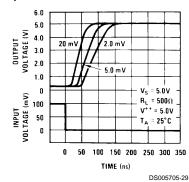
DS005705-27

Typical Performance Characteristics LM319A, LM319 (Continued)

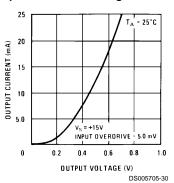
Response Time for Various Input Overdrives



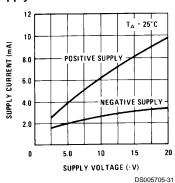
Response Time for Various Input Overdrives



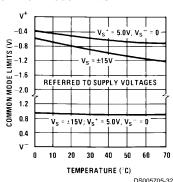
Output Saturation Voltage



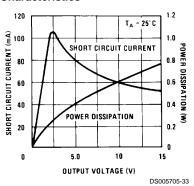
Supply Current



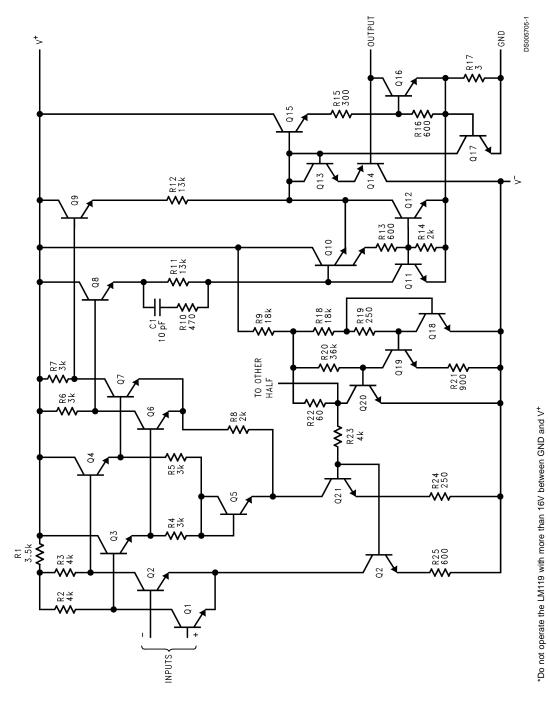
Common Mode Limits



Output Limiting Characteristics

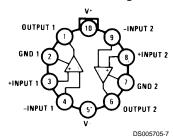


Schematic Diagram



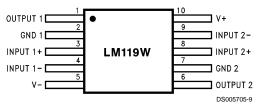
Connection Diagrams

Metal Can Package



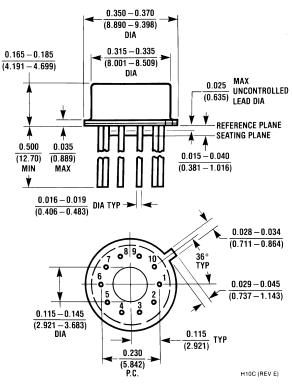
Case is connected to pin 5 (V-)

Top View
Order Number LM119H, LM119H/883 (Note 1),
or LM319H
See NS Package Number H10C

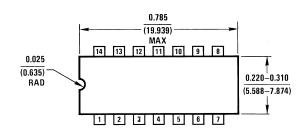


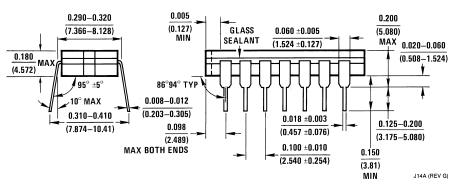
Order Number LM119W/883 See NS Package Number W10A

Physical Dimensions inches (millimeters) unless otherwise noted



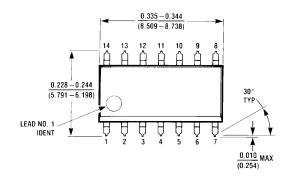
Metal Can Package (H)
Order Number LM119H, LM119H/883, LM319AH or LM319H
NS Package Number H10C

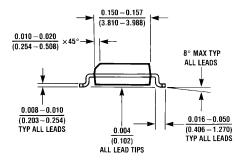


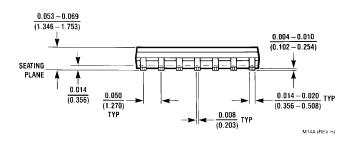


Cavity Dual-In-Line Package (J)
Order Number LM119J, LM119J/883, LM219J, LM319AJ or LM319J
NS Package Number J14A

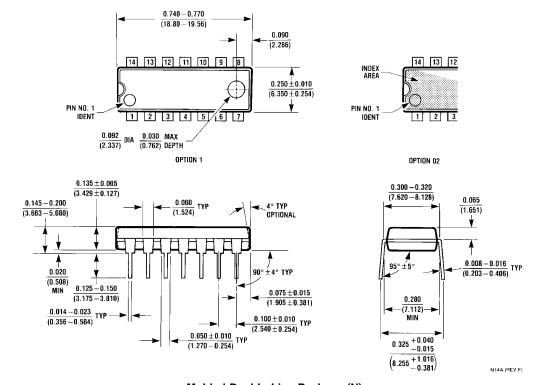
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)





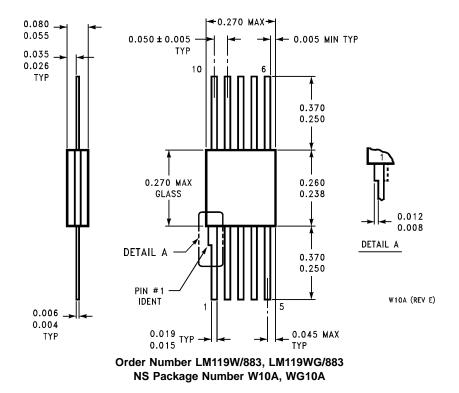


Dual-In-Line Package (M)
Order Number LM319AM or LM319M
NS Package Number M14A



Molded Dual-In-Line Package (N) Order Number LM319AN or LM319N NS Package Number N14A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



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